



(社)日本半導体製造装置協会

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2007年11月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 12月度BBレシオ 1/22 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2007年11月度のBBレシオは0.87

東京 2007年12月18日 - 日本半導体製造装置協会が18日に発表した11月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**129,901**百万円(3ヶ月移動平均)、BBレシオは**0.87**だった。BBレシオ0.87は100円で販売したのに対し87円の新たな受注があったことを示す。

受注額は前月比**2.2%**増(2007年10月度確定値は**127,056**百万円)、前年同月比**21.0%**減(2006年11月度は**164,465**百万円)の**129,901**百万円だった。

販売額は前月比**7.8%**減(2007年10月度確定値は**161,892**百万円)、前年同月比**2.6%**増(2006年11月度は**145,506**百万円)の**149,315**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2007/6	151,834	155,546	1.02
2007/7	166,458	147,058	0.88
2007/8	172,772	139,673	0.81
2007/9	176,126	129,323	0.73
2007/10(確定値)	161,892	127,056	0.78
2007/11(暫定値)	149,315	129,901	0.87

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を発表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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November 2007 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. **The December Report SEAJ's Web site update** is scheduled **on Tuesday, 22nd January** approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **November 2007 Book-to-Bill Ratio of 0.87**

Tokyo Japan., **December 19 2007** -- JAPAN-based manufacturers of semiconductor equipment posted **¥ 129,901 million** in orders in **November 2007** (three-month average basis) and a BB Ratio of **0.87** according to the **November 2007** BB Ratio published today by SEAJ. A book-to-bill of **0.87** means that **¥ 87** worth of new orders was received for every ¥100 of product billed for the month.

The three-month average of worldwide bookings in **November 2007** was **¥ 129,901 million**. The bookings figure is **2.2 percent up the final October 2007** level of **¥ 127,056 million** and **21.0 percent down the ¥ 164,465 million** in orders posted in **November 2006**.

The three-month average of worldwide billings in **November 2007** was **149,315million**. The billings figure is **7.8 percent down the final October 2007** level of **¥ 161,892 million** and **2.6 percent up the November 2006** billings level of **¥ 145,506 million**. The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill
June 2007	151,834	155,546	1.02
July 2007	166,458	147,058	0.88
August 2007	172,772	139,673	0.81
September 2007	176,126	129,323	0.73
October 2007(final)	161,892	127,056	0.78
November 2007(prelim)	149,315	129,901	0.87

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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